Special Issue on
Advanced Micro and Nanomaterials for Various Sensor Applications
(Selected Papers from ICASI 2020)

Special Issue Information

Various sensors and flexible optoelectronics are attracting a great deal of attention in recent years due to their potential applications in healthcare monitoring, biomedicine, electronic skin, wearable sensing technology, soft robotics, flat panel displays, safety equipments, smart systems and future space applications. The aim of this special issue is to publish novel and high quality research papers (experimental, theoretical, or simulation works) as well as review articles addressing recent advances on cutting-edge flexible electronics and sensors based on micro/nanomaterials. Research and review articles should provide a comprehensive insight into characterization and understanding of functional micro/nanomaterials properties with the application of scanning techniques. Manuscript submitted to Sensors and Materials journal must be not published previously or under consideration for publication elsewhere. Potential topics include, but are not limited to:

- Design, synthesis and characterization of functional micro/nanomaterials for sensing applications and electronic devices
- Chemical and gas sensors based on micro/nano sensing materials
- Advanced materials in mechatronics applications
- Molecular dynamics simulation and quantum chemical calculations for micro/nanomaterials related to sensing applications and flexible electronics
- Theories and principles related to micro/nanomaterials, chemical and gas sensing, and flexible electronics
- Sensors and flexible electronics for future food and agricultural applications
- Advanced scanning techniques for characterization of sensors and flexible electronics

Schedule
Manuscript Due: July 31, 2021
First Round of Reviews: August 31, 2021
Second Round of Reviews: October 25, 2021
Acceptance of Final papers: November 30, 2021
Publication (planned): January 31, 2022
Lead Guest Editor
Sheng-Joue Young, Professor
Department of Electronic Engineering, National Formosa University, Yunlin, Taiwan
youngsj@nfu.edu.tw

Guest Editors
Chair Prof. Shou-Jinn Chang, IEEE fellow, OSA fellow, SPIE fellow
Department of Electrical Engineering, National Cheng Kung University, Tainan 701, Taiwan
changsj@mail.ncku.edu.tw

Liang-Wen Ji, Professor
Institute of Electro-Optical and Materials Science, National Formosa University
lwji@seed.net.tw

Yu-Jen Hsiao, Professor
Department of Mechanical Engineering, Southern Taiwan University of Science and Technology
yujenhsiao.tw@gmail.com

(Attention)
As stated in Instructions to Authors in the Guidelines, the author(s) will be obliged to pay the publication fee upon the acceptance of the manuscript for publication (for example, JPY 99360 for 10 pages in Sensors and Materials format). If the quality of the English of your manuscript does not satisfy the journal standards, the authors will bear the proofreading fee (JPY 10000–15000 for electronic proofreading), which will be charged with the publication fee.

If you have any questions, please feel free to contact the editorial staff at the address below.

Editorial Department of Sensors and Materials
MYU K.K.
1-23-3-303 Sendagi, Bunkyo-ku, Tokyo 113-0022, Japan
Tel: +81-3-3827-8549, Fax: +81-3-3827-8547
E-mail: myukk@myu-inc.jp